

QM2422M3

N-Channel 20V Fast Switching MOSFET

General Description

The QM2422M3 is a high performance trench N-channel MOSFET which utilizes extremely high cell density to provide low $R_{DS(on)}$ and gate charge characteristics. It is ideally suited to support synchronous buck converter applications.

The QM2422M3 meets RoHS and Green Product requirements while supporting full function reliability.

Features

- ✓ Advanced high cell density Trench technology
- ✓ Super Low Gate Charge
- ✓ Excellent CdV/dt effect decline
- ✓ Green Device Available
- ✓ HBM 2KV / MM 200V Verified

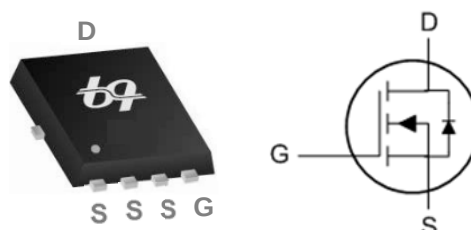
Product Summary

V_{DS}	$R_{DS(ON)} \max$ ($V_{GS}=4.5V$)	I_D ($T_C=25^\circ C$)
20V	4.6m Ω	80A

Applications

- ✓ High Frequency Point-of-Load Synchronous Buck Converter for MB/NB/UMPC/VGA
- ✓ Networking DC-DC Power System
- ✓ Load Switch

Pin Configuration



Ordering Information

Order Number	Package Type	Top Marking
QM2422M3	PRPAK3X3	M 2 4 2 2 M X X X X X → Product Name → Date Code → Assy Code → Sequence → Weekly → Yearly Pin 1 dot →

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Absolute Maximum Ratings

Symbol	Parameter	Rating	Units
V_{DS}	Drain-Source Voltage	20	V
V_{GS}	Gate-Source Voltage	± 12	V
$I_D@T_C=25^{\circ}C$	Continuous Drain Current, $V_{GS} @ 10V^1$	80	A
$I_D@T_C=100^{\circ}C$	Continuous Drain Current, $V_{GS} @ 10V^1$	50	A
$I_D@T_A=25^{\circ}C$	Continuous Drain Current, $V_{GS} @ 10V^1$	16	A
$I_D@T_A=70^{\circ}C$	Continuous Drain Current, $V_{GS} @ 10V^1$	12.8	A
I_{DM}	Pulsed Drain Current ²	180	A
$P_D@T_C=25^{\circ}C$	Total Power Dissipation ³	43.4	W
$P_D@T_A=25^{\circ}C$	Total Power Dissipation ³	1.7	W
T_{STG}	Storage Temperature Range	-55 to 150	$^{\circ}C$
T_J	Operating Junction Temperature Range	-55 to 150	$^{\circ}C$

Thermal Data

Symbol	Parameter	Typ.	Max.	Unit
$R_{\theta JA}$	Thermal Resistance Junction-Ambient ¹	--	75	$^{\circ}C/W$
$R_{\theta JC}$	Thermal Resistance Junction-Case ¹	--	2.88	$^{\circ}C/W$

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N-Channel Electrical Characteristics

N-Channel Electrical Characteristics: (T _J =25 °C, unless otherwise noted)						
Symbol	Parameter	Conditions	Min	Typ	Max	Unit
B _{VDS}	Drain-Source Breakdown Voltage	V _{GS} =0V, I _D =250uA	20	--	--	V
ΔB _{VDS} /ΔT _J	B _{VDS} Temperature Coefficient	Reference to 25°C, I _D =1mA	--	0.021	--	V/°C
R _{DS(ON)}	Static Drain-Source On-Resistance ²	V _{GS} =4.5V, I _D =15A	2.1	3.6	4.6	mΩ
		V _{GS} =3.8V, I _D =15A	2.4	3.9	4.9	
		V _{GS} =3.1V, I _D =15A	2.5	4.3	5.4	
		V _{GS} =2.5V, I _D =15A	2.8	4.6	5.8	
V _{GS(th)}	Gate Threshold Voltage	V _{GS} =V _{DS} , I _D =250uA	0.5	0.7	1.2	V
ΔV _{GS(th)}	V _{GS(th)} Temperature Coefficient		--	-5.73	--	mV/°C
I _{DSS}	Drain-Source Leakage Current	V _{DS} =16V, V _{GS} =0V, T _J =25°C	--	--	1	uA
		V _{DS} =16V, V _{GS} =0V, T _J =55°C	--	--	5	
I _{GSS}	Gate-Source Leakage Current	V _{GS} =±12V, V _{DS} =0V	--	--	±100	nA
g _{fs}	Forward Transconductance	V _{DS} =5V, I _D =20A	--	53	--	S
R _g	Gate Resistance	V _{DS} =0V, V _{GS} =0V, f=1MHz	--	1.1	2.2	Ω
Q _g	Total Gate Charge	V _{DS} =15V, V _{GS} =4.5V, I _D =15A	--	92	--	nC
Q _{gs}	Gate-Source Charge		--	21	--	
Q _{gd}	Gate-Drain Charge		--	28	--	
t _{d(on)}	Turn-On Delay Time	V _{DS} =10V, V _{GS} =10V, R _G =3.3Ω, I _D =15A	--	11.2	--	ns
t _r	Rise Time		--	59	--	
t _{d(off)}	Turn-Off Delay Time		--	130	--	
t _f	Fall Time		--	22.4	--	
C _{iss}	Input Capacitance	V _{DS} =10V, V _{GS} =0V, f=1MHz	--	5207	--	pF
C _{oss}	Output Capacitance		--	500	--	
C _{rss}	Reverse Transfer Capacitance		--	450	--	

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Diode Characteristics

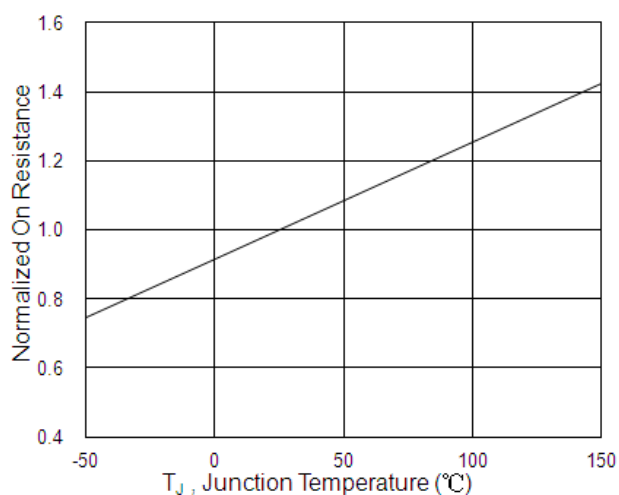
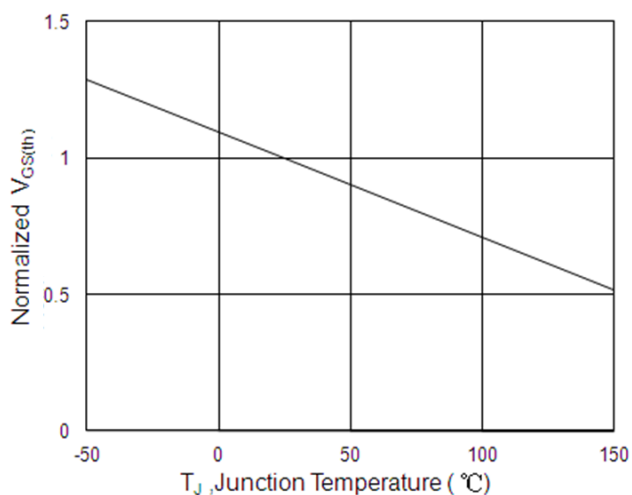
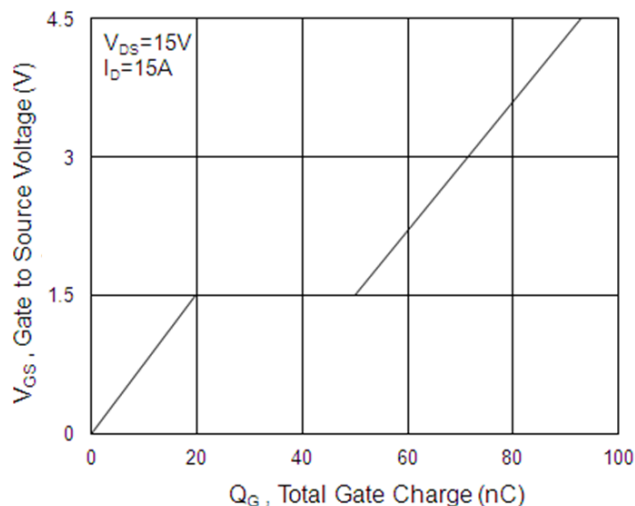
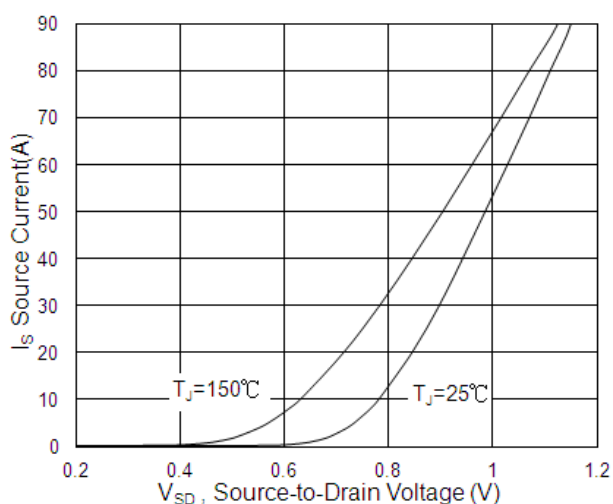
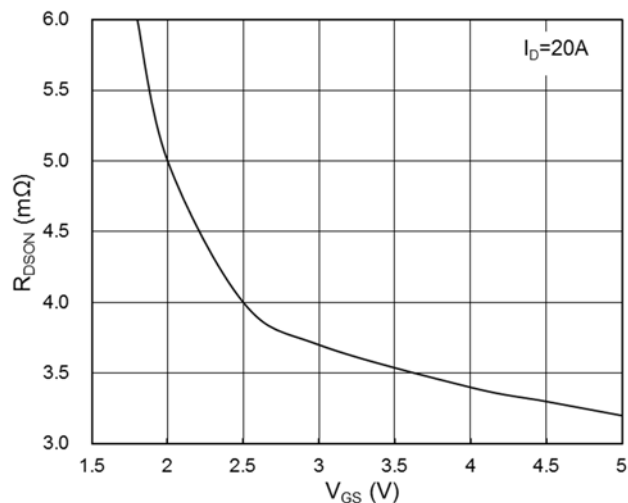
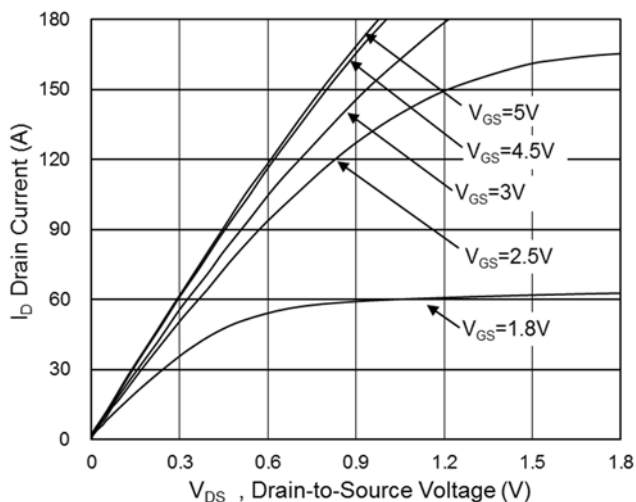
Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
I_S	Continuous Source Current ^{1,4}	$V_G=V_D=0V$, Force Current	--	--	80	A
I_{SM}	Pulsed Source Current ^{2,4}		--	--	160	A
V_{SD}	Diode Forward Voltage ²	$V_{GS}=0V$, $I_S=1A$, $T_J=25^{\circ}C$	--	--	1	V
t_{rr}	Reverse Recovery Time	$I_F=15A$, $di/dt=100A/\mu s$, $T_J=25^{\circ}C$	--	14	--	nS
Q_{rr}	Reverse Recovery Charge		--	5.9	--	nC

Note:

1. Test data conducted with surface mount attachment to 1 inch², FR-4 board utilizing 2oz copper
2. Pulse Test. Pulse width $\leq 300\mu s$, duty cycle $\leq 2\%$
3. The power dissipation is limited by a 150°C maximum junction temperature
4. The data is theoretically the same as I_D and I_{DM} . In real applications, it will be limited by total power

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Typical Characteristics



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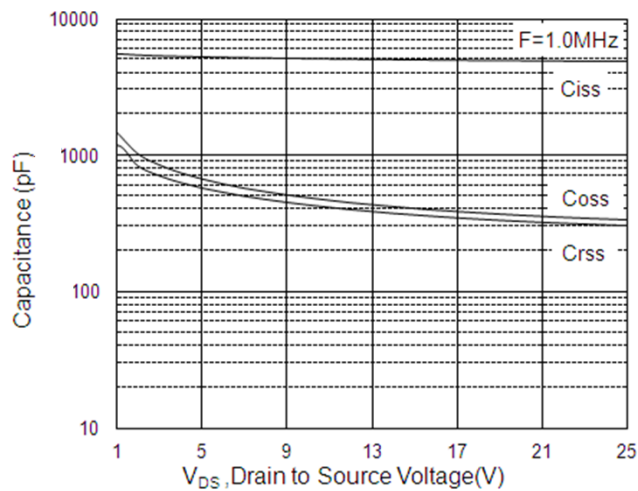


Fig.7: Capacitance

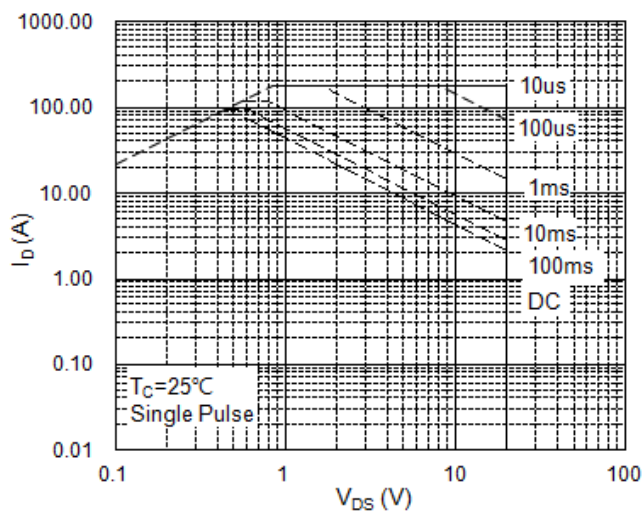


Fig.8: Safe Operating Area

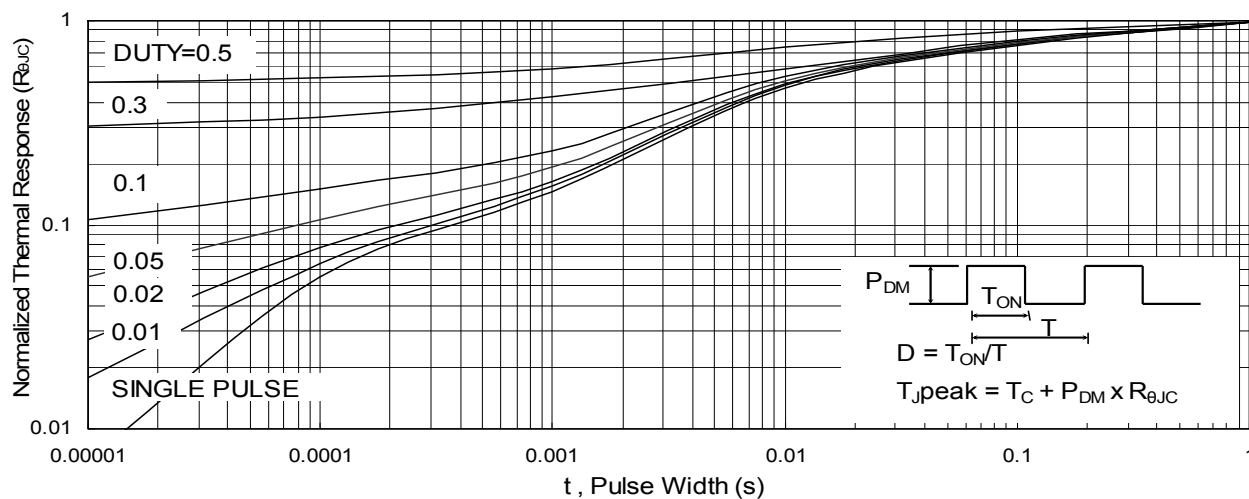


Fig.9: Normalized Maximum Transient Thermal Impedance

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